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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Continuation Patent
Application of 08/968,456

Hideaki KURODA

Group Art Unit: 2822

Application No. to be assigned

Examiner: M. Prenty

Filed: May 29, 2001

For: SEMICONDUCTOR DEVICE
HAVING THREE CONNECTION HOLES
(as amended)

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

The present application is a continuation of the Patent
Application No. 08/968,456 filed November 12, 1997. Prior to an
initial examination of the above-identified patent application,
please amend the application as follows:

IN THE SPECIFICATION:

Please replace the paragraph beginning on page 1, line 7, with
the following rewritten paragraph:

subb
a'
--The present invention relates to a semiconductor device
and a method of manufacturing the same, and, more particularly,
to a structure of a contact portion for taking out a conductive
layer pattern of a diffusion layer, a wiring layer, etc. located
at a deep position of the semiconductor device and a method of
manufacturing the same.--